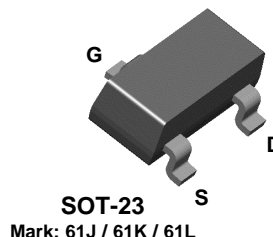
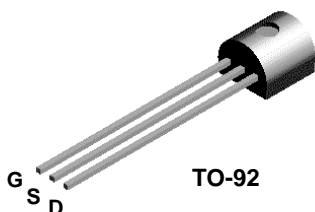


**PN4091
PN4092
PN4093**

**MMBF4091
MMBF4092
MMBF4093**



NOTE: Source & Drain
are interchangeable

N-Channel Switch

This device is designed for low level analog switching, sample and hold circuits and chopper stabilized amplifiers. Sourced from Process 51. See J111 for characteristics.

Absolute Maximum Ratings*

TA = 25°C unless otherwise noted

| Symbol | Parameter | Value | Units |
|----------------|--|-------------|-------|
| V_{DG} | Drain-Gate Voltage | 40 | V |
| V_{GS} | Gate-Source Voltage | - 40 | V |
| I_{GF} | Forward Gate Current | 50 | mA |
| T_J, T_{stg} | Operating and Storage Junction Temperature Range | -55 to +150 | °C |

*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

- 1) These ratings are based on a maximum junction temperature of 150 degrees C.
- 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations

Thermal Characteristics

TA = 25°C unless otherwise noted

| Symbol | Characteristic | Max | | Units |
|-----------------|---|-------------|----------------|-------|
| | | PN4091-4093 | *MMBF4091-4093 | |
| P_D | Total Device Dissipation | 625 | 350 | mW |
| | Derate above 25°C | 5.0 | 2.8 | mW/°C |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | 125 | | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient | 357 | 556 | °C/W |

*Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06."

N-Channel Switch

(continued)

Electrical Characteristics

TA = 25°C unless otherwise noted

| Symbol | Parameter | Test Conditions | Min | Max | Units |
|--------|-----------|-----------------|-----|-----|-------|
|--------|-----------|-----------------|-----|-----|-------|

OFF CHARACTERISTICS

| | | | | | |
|----------------------|-------------------------------|---|-------------|-------|-------|
| V _{(BR)GSS} | Gate-Source Breakdown Voltage | I _G = 1.0 μA, V _{DS} = 0 | | - 40 | V |
| V _{GS(off)} | Gate-Source Cutoff Voltage | V _{DS} = 20 V, I _D = 1.0 nA | 4091 | - 5.0 | - 10 |
| | | | 4092 | - 2.0 | - 7.0 |
| | | | 4093 | - 1.0 | - 5.0 |
| I _{DGO} | Drain-Gate Leakage Current | V _{DG} = 20 V, I _S = 0 | | - 200 | pA |
| | | V _{DG} = 20 V, I _S = 0, T _A = 150°C | | - 400 | nA |
| I _{D(off)} | Drain Cutoff Leakage Current | V _{DS} = 20 V, V _{GS} = - 12 V | 4091 | | 200 |
| | | V _{DS} = 20 V, V _{GS} = - 8.0 V | 4092 | | 200 |
| | | V _{DS} = 20 V, V _{GS} = - 6.0 V | 4093 | | 200 |
| | | V _{DS} = 20 V, V _{GS} = - 12 V, T _A = 150°C | 4091 | | 400 |
| | | V _{DS} = 20 V, V _{GS} = - 8.0 V, T _A = 150°C | 4092 | | 400 |
| | | V _{DS} = 20 V, V _{GS} = - 6.0 V, T _A = 150°C | 4093 | | 400 |
| | | V _{DS} = 20 V, V _{GS} = - 6.0 V, T _A = 150°C | 4093 | | 400 |

ON CHARACTERISTICS

| | | | | | |
|---------------------|----------------------------------|--|-------------|-----|-----|
| I _{DSS} | Zero-Gate Voltage Drain Current* | V _{DS} = 20 V, V _{GS} = 0 | 4091 | 30 | mA |
| | | | 4092 | 15 | mA |
| | | | 4093 | 8.0 | mA |
| V _{DS(on)} | Drain-Source On Voltage | I _D = 6.6 mA, V _{GS} = 0 | 4091 | | 0.2 |
| | | I _D = 4.0 mA, V _{GS} = 0 | 4092 | | 0.2 |
| | | I _D = 2.5 mA, V _{GS} = 0 | 4093 | | 0.2 |
| r _{DS(on)} | Drain-Source On Resistance | I _D = 1.0 mA, V _{GS} = 0 | 4091 | | 30 |
| | | | 4092 | | 50 |
| | | | 4093 | | 80 |

SMALL-SIGNAL CHARACTERISTICS

| | | | | | |
|---------------------|------------------------------|--|-------------|--|-----|
| r _{ds(on)} | Drain-Source On Resistance | V _{DS} = V _{GS} = 0, f = 1.0 kHz | 4091 | | 30 |
| | | | 4092 | | 50 |
| | | | 4093 | | 80 |
| C _{iss} | Input Capacitance | V _{DS} = 20, V _{GS} = 0, f = 1.0 MHz | | | 16 |
| C _{rss} | Reverse Transfer Capacitance | V _{GS} = - 20 V, f = 1.0 MHz | | | 5.0 |

SWITCHING CHARACTERISTICS

| | | | | | |
|------------------|---------------|------------------------------|-------------|--|----|
| t _{on} | Turn-On Time | I _{D(on)} = 12 mA | 4091 | | 25 |
| | | I _{D(on)} = 6.0 mA | 4092 | | 35 |
| | | I _{D(on)} = 3.0 mA | 4093 | | 60 |
| t _{off} | Turn-Off Time | V _{GS(off)} = 12 V | 4091 | | 40 |
| | | V _{GS(off)} = 6.0 V | 4092 | | 60 |
| | | V _{GS(off)} = 3.0 V | 4093 | | 80 |

*Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 1.0%

PN4091 / 4092 / 4093 / MMBF4091 / 4092 / 4093

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PRODUCT STATUS DEFINITIONS

Definition of Terms

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|--------------------------|------------------------|---|
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